

# **3-D Position-Sensitive CdZnTe $\gamma$ -Ray Spectrometers**

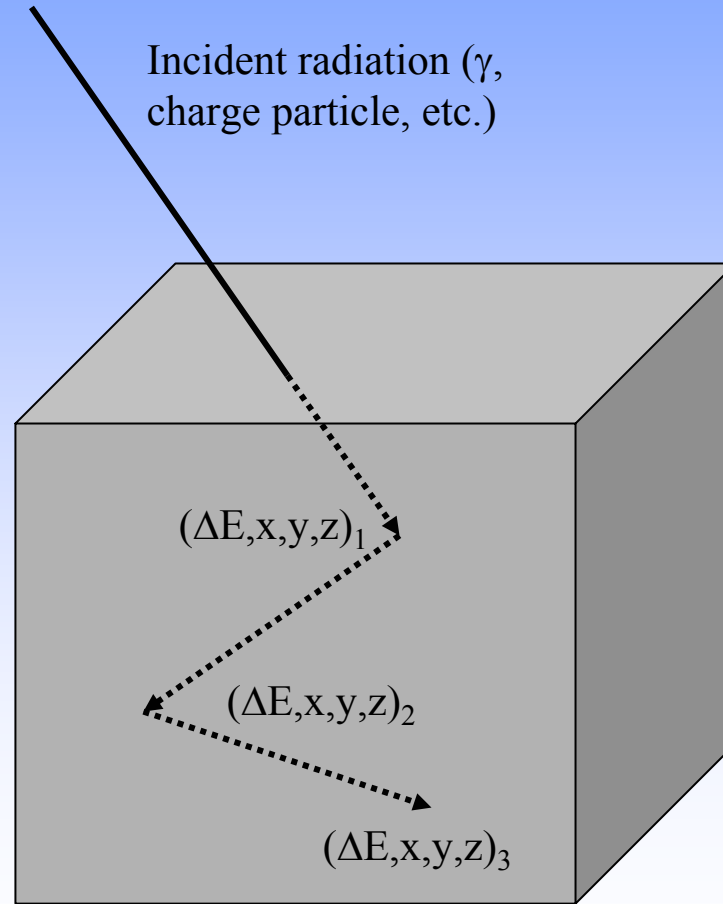
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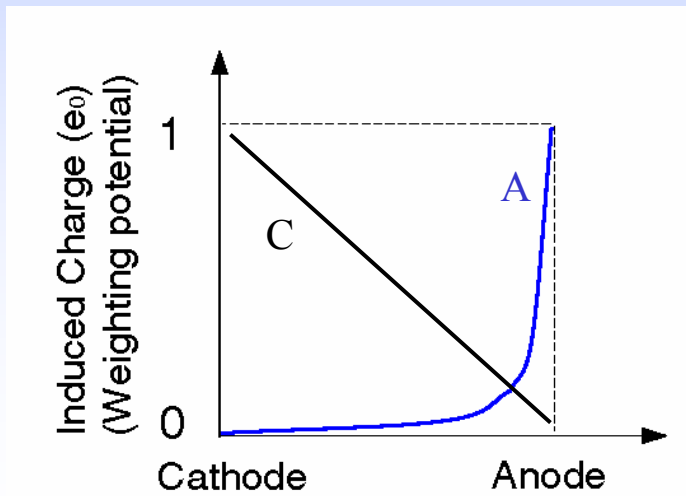
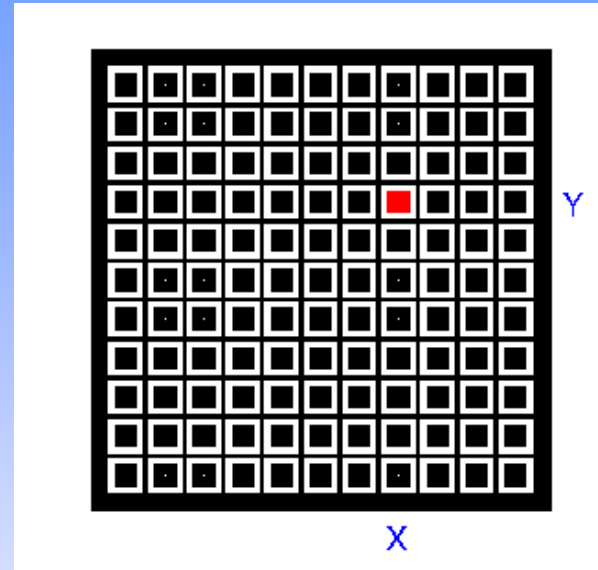
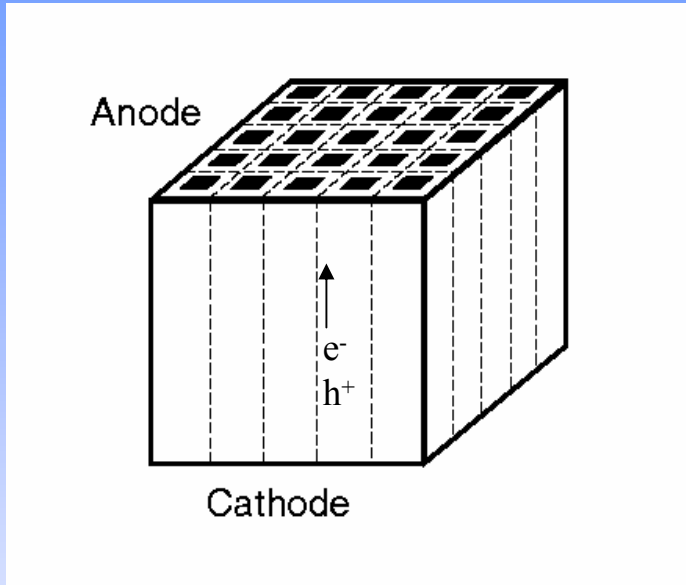
Acknowledgements

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# What is a 3-dimensional position-sensitive semiconductor detector?



# Principle of Operation



From pixel #i :  $(E', x, y)$

Depth  $z = C/A = C/E'$

$(E', z)_i \Rightarrow E_0$  (True E)

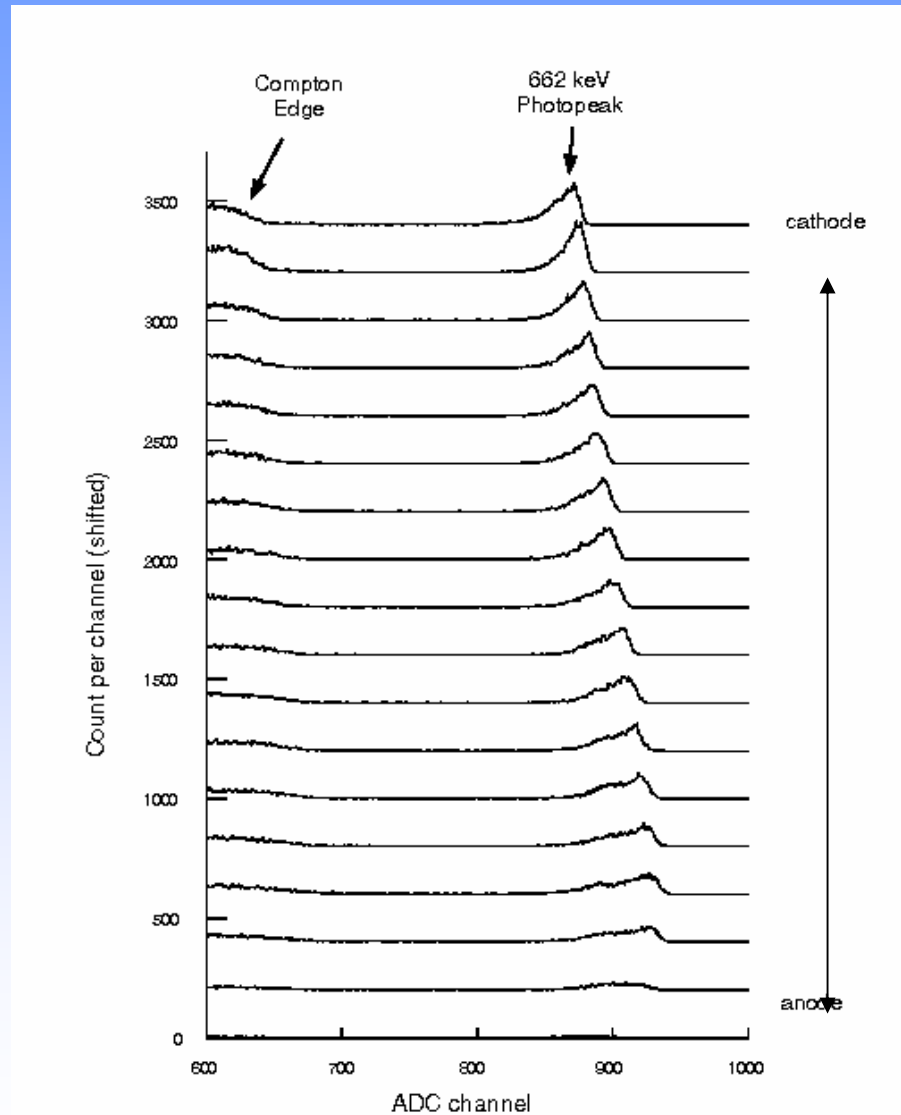


$(E_0, x, y, z)$

# Advantageous of 3-D detectors

- Single polarity charge sensing → Overcome the effects of severe hole trapping
- Depth sensing → Correct electron trapping
- 3-D coordinates of interactions → Mitigate the effects of material non-uniformity to the scale of position resolution ( $\sim 1\text{mm}$ )
- Minimum electronic noise (leakage current & detector capacitance are shared between pixels)
- $\gamma$ -ray imaging
- **Detector physics** (increase sensitivity by recognizing signatures of radiation interactions)

# The effect of electron trapping

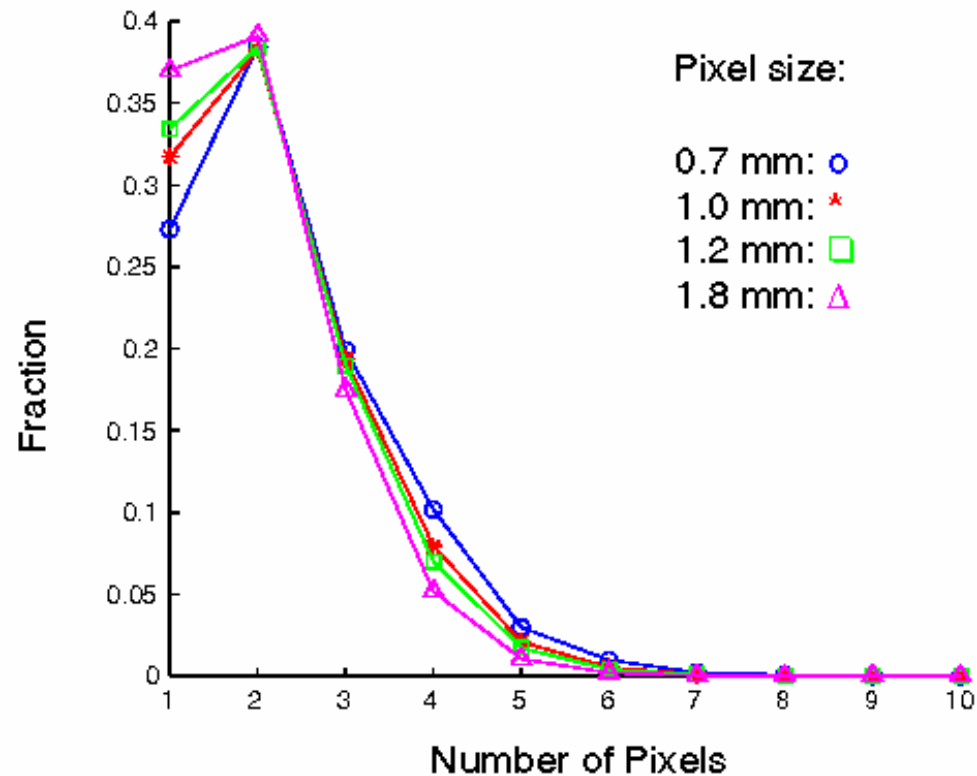


There are virtually  
~**2400** voxel detectors  
on each device.

Results of first-generation detectors ( $1 \text{ cm}^3$ ) were reported during 1998-2001

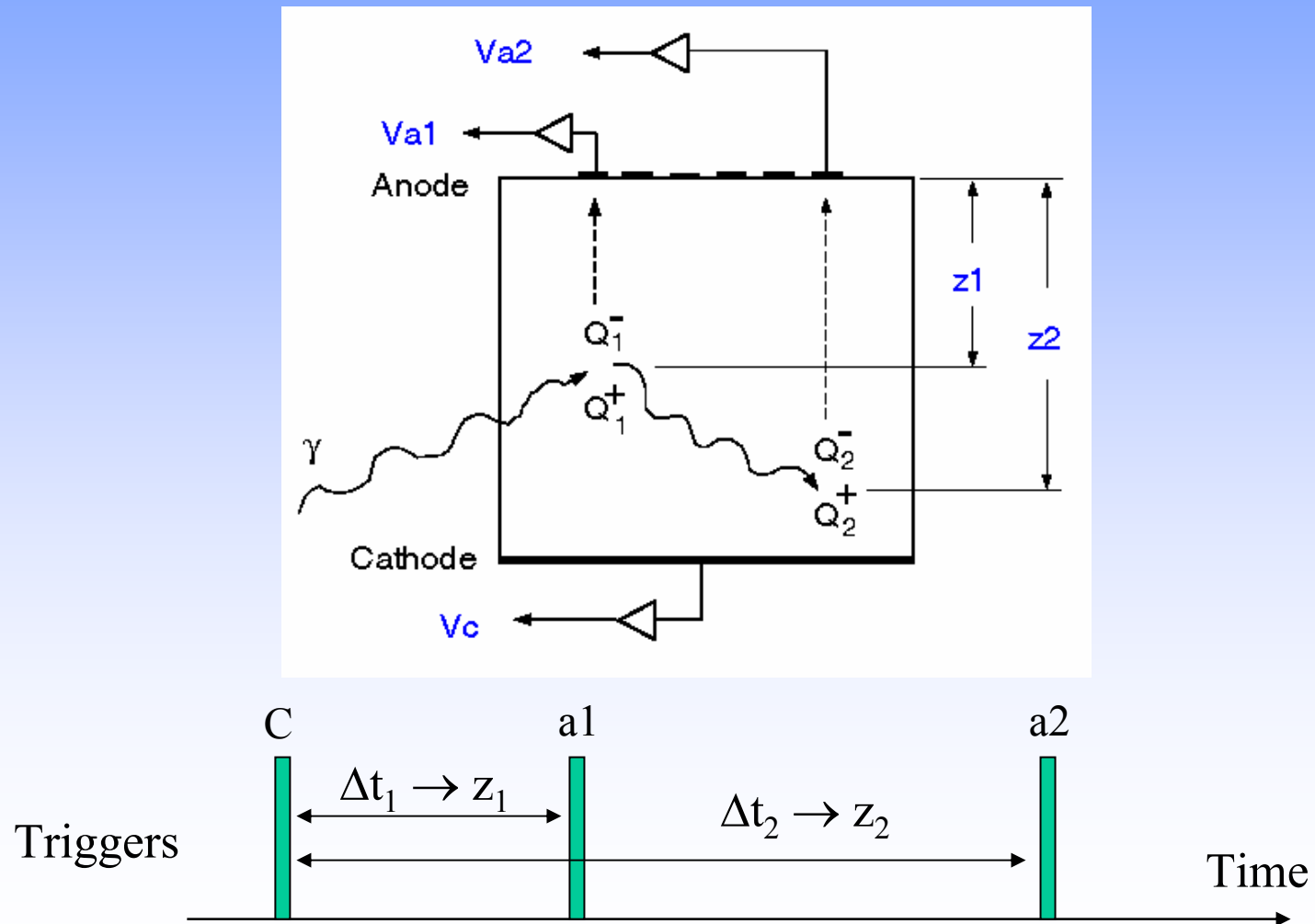
# Importance of multiple interaction events

Modeled Fraction of 662 keV Multiple-Pixel Full Energy Deposition Events



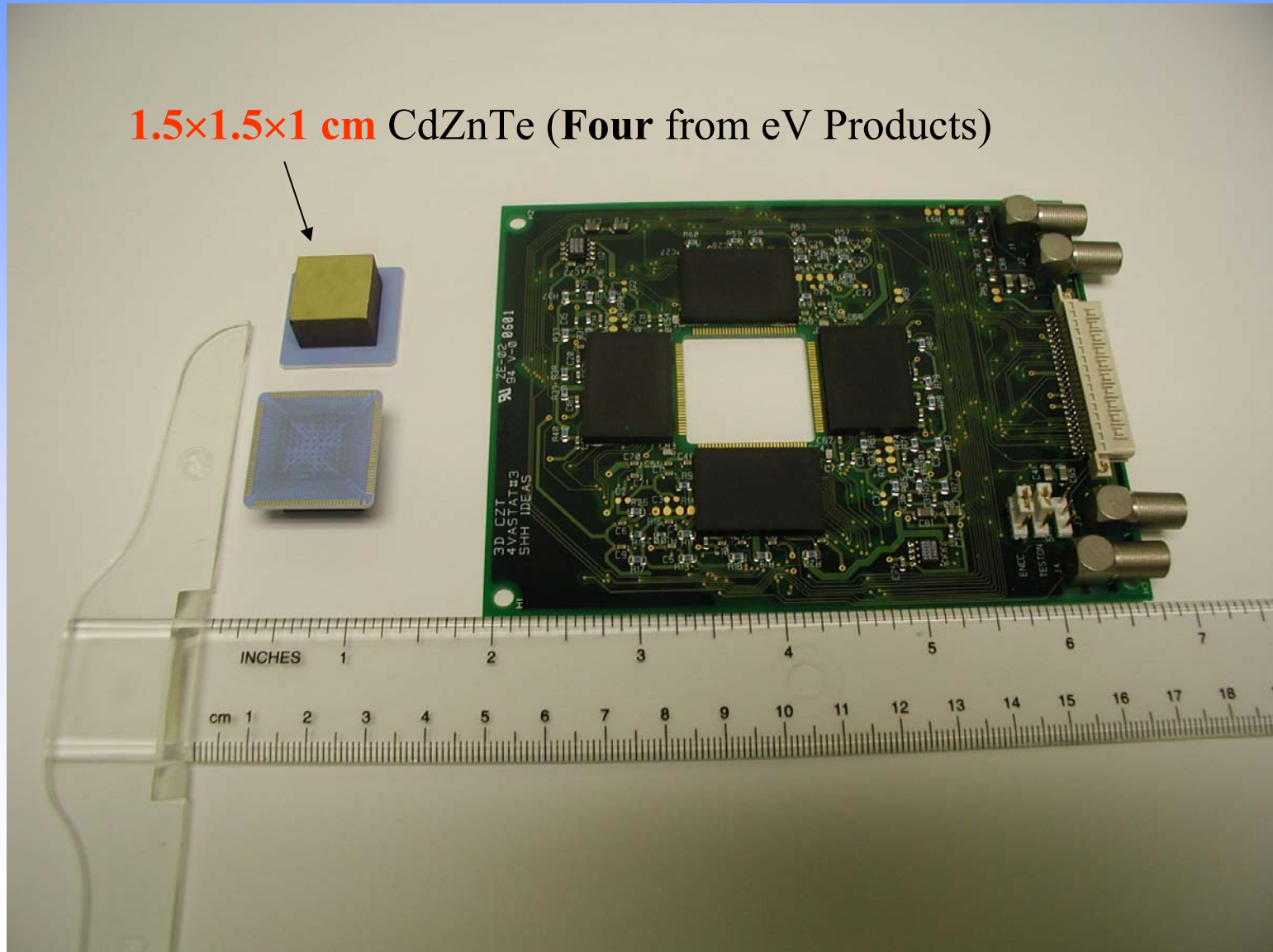
The size of electron cloud was considered

Second-generation 3-D CdZnTe detectors can provide  $(E, x, y, z)_i$  of multiple  $\gamma$ -ray interactions



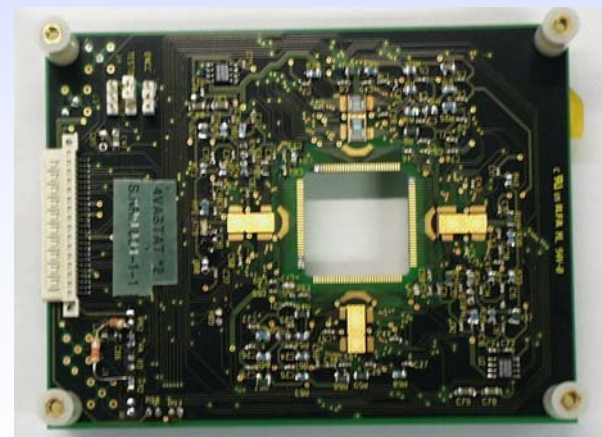
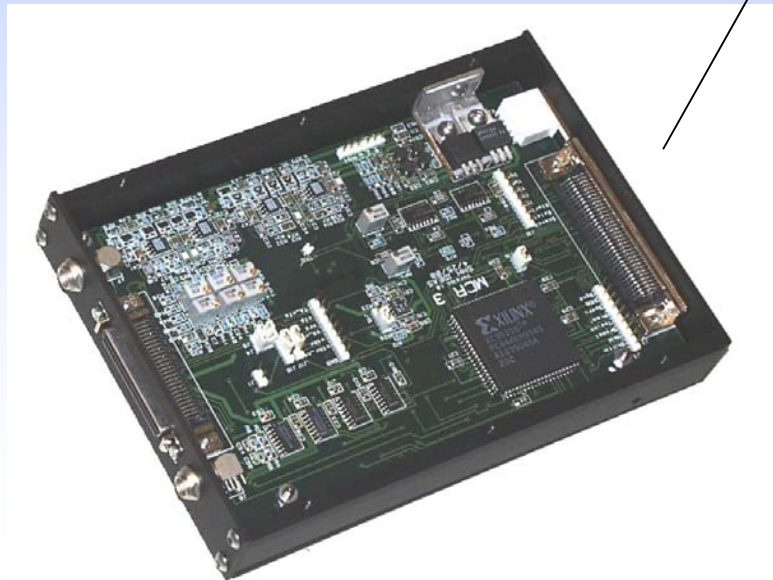
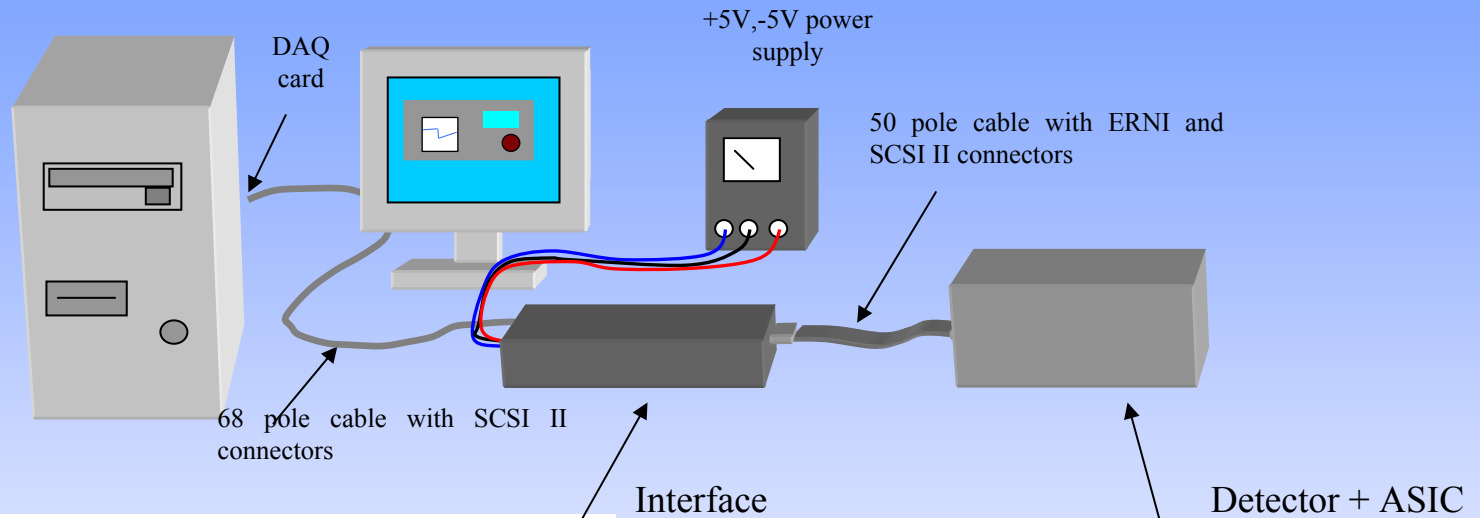
# Detector front-end

**1.5×1.5×1 cm** CdZnTe (Four from eV Products)



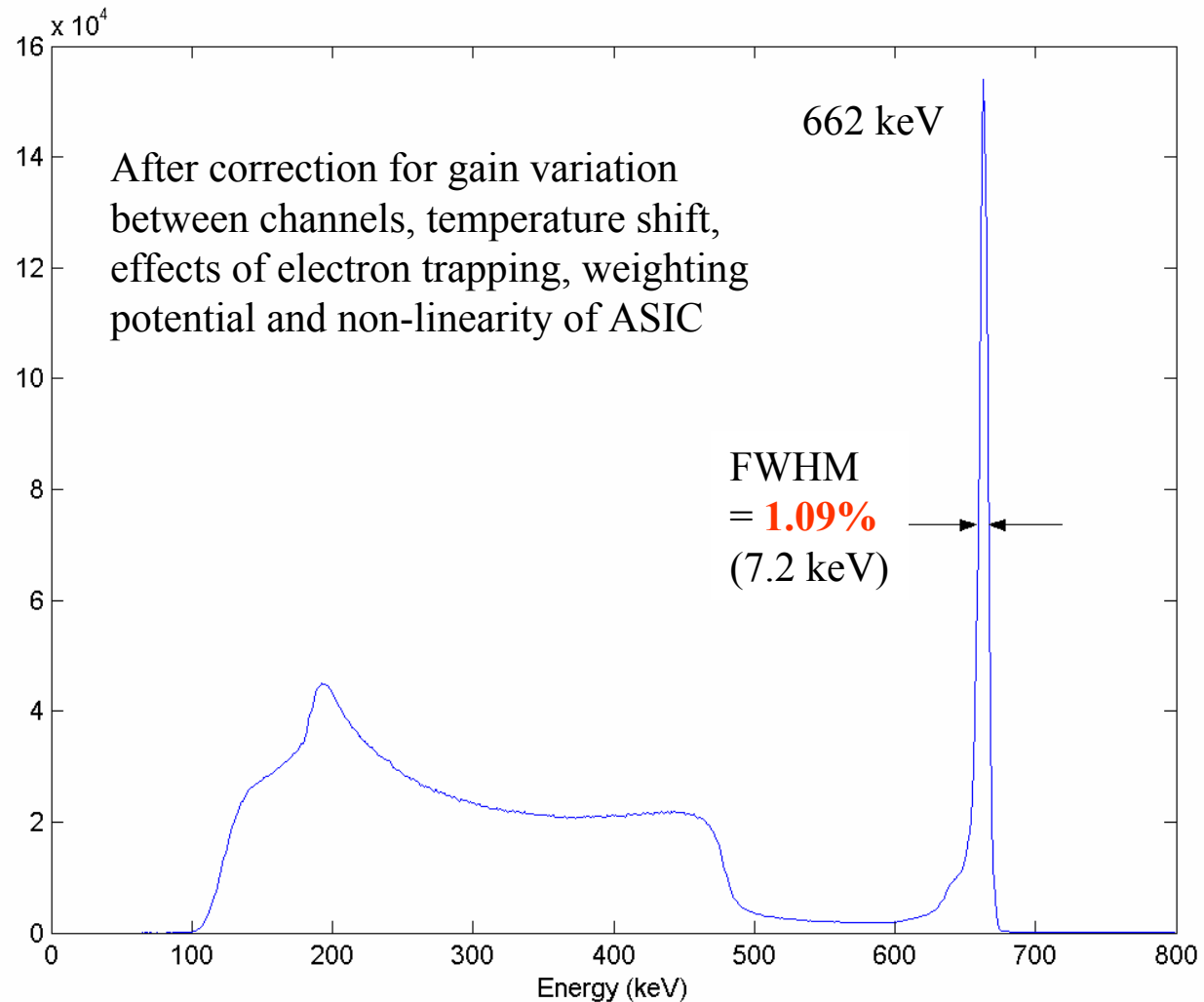


# Detector system



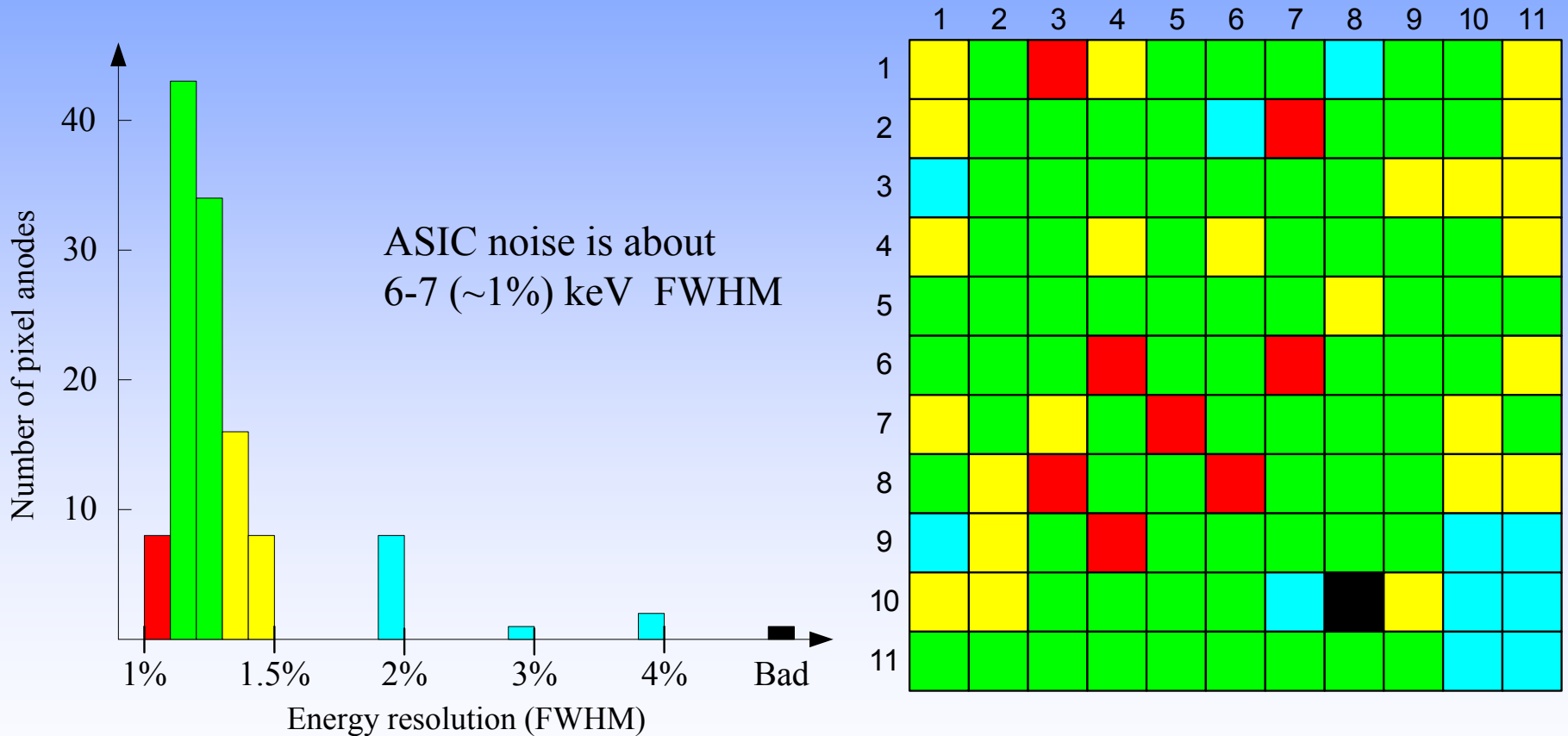
# Energy spectrum of $^{137}\text{Cs}$ from **one-pixel** events

Detector # **2.3** (120 working pixels):  $V_C = -2000\text{ V}$ ;  $V_{A-G} = 80\text{ V}$



# Distribution of energy resolutions (**one-pixel** events)

Detector # **2.2** (120 working pixels):  $V_C = -1400$  V;  $V_{A-G} = 90$  V; Time = **50 h**

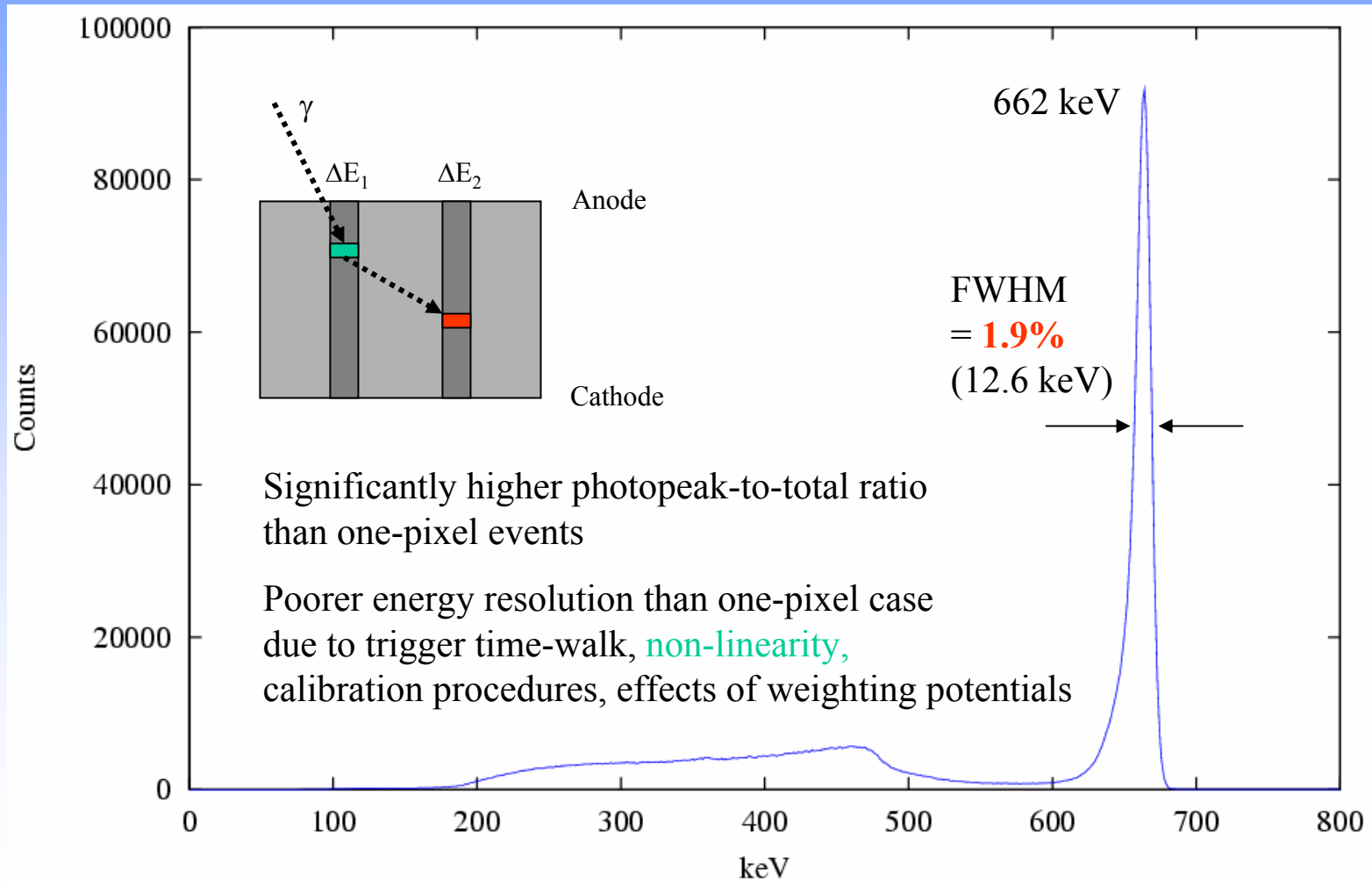


ASIC noise is about 6-7 (~1%) keV FWHM

**Energy resolution can be further improved if the ASIC noise can be reduced from 6-7 keV (~ 1%) to ~ 3 keV (0.5%) FWHM as planned**

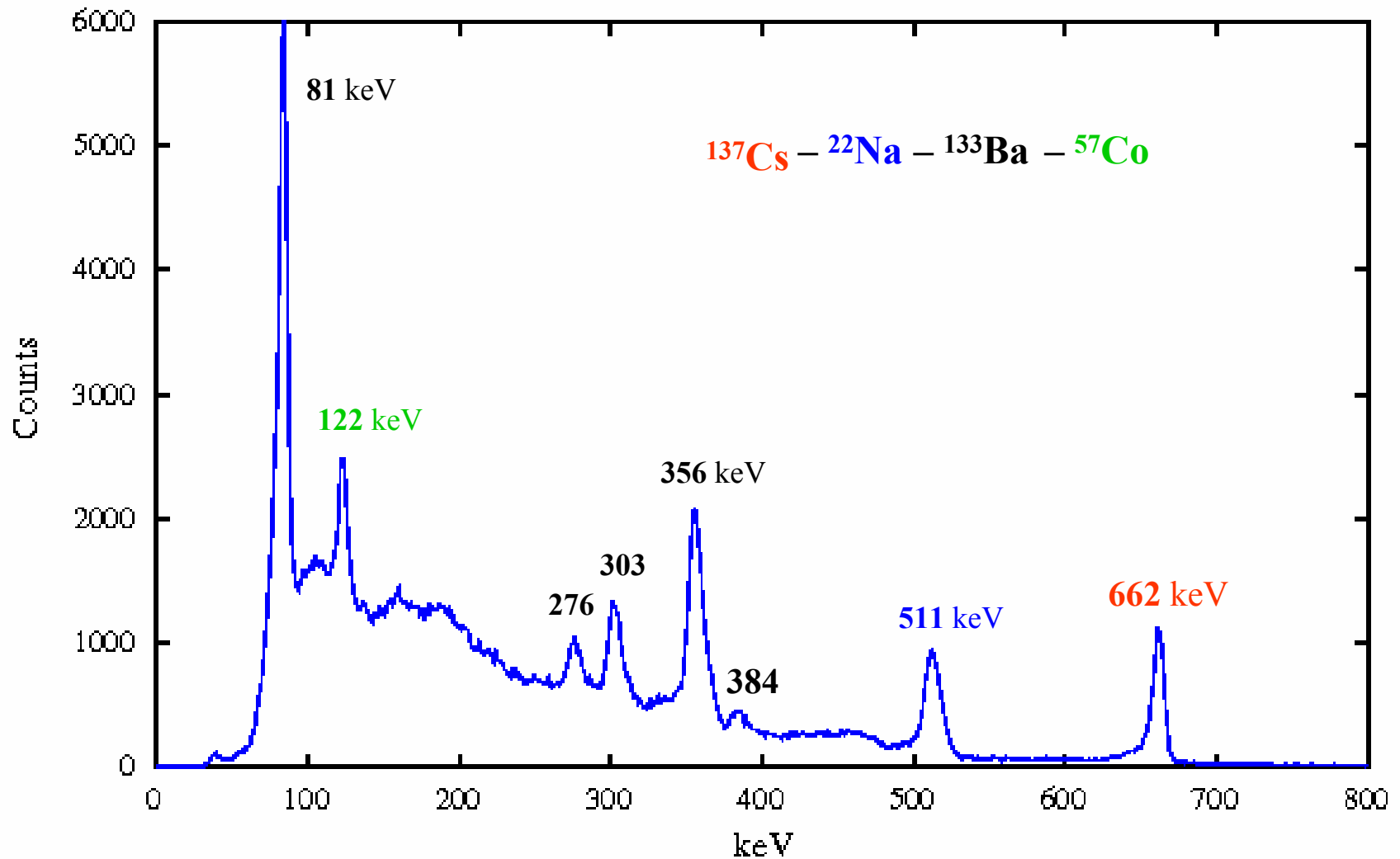
# Energy spectra of $^{137}\text{Cs}$ from **two-pixel** events

Detector # **2.3**:  $V_C = -2000\text{ V}$ ;  $V_{A-G} = 80\text{ V}$ ; Time = **50 h**



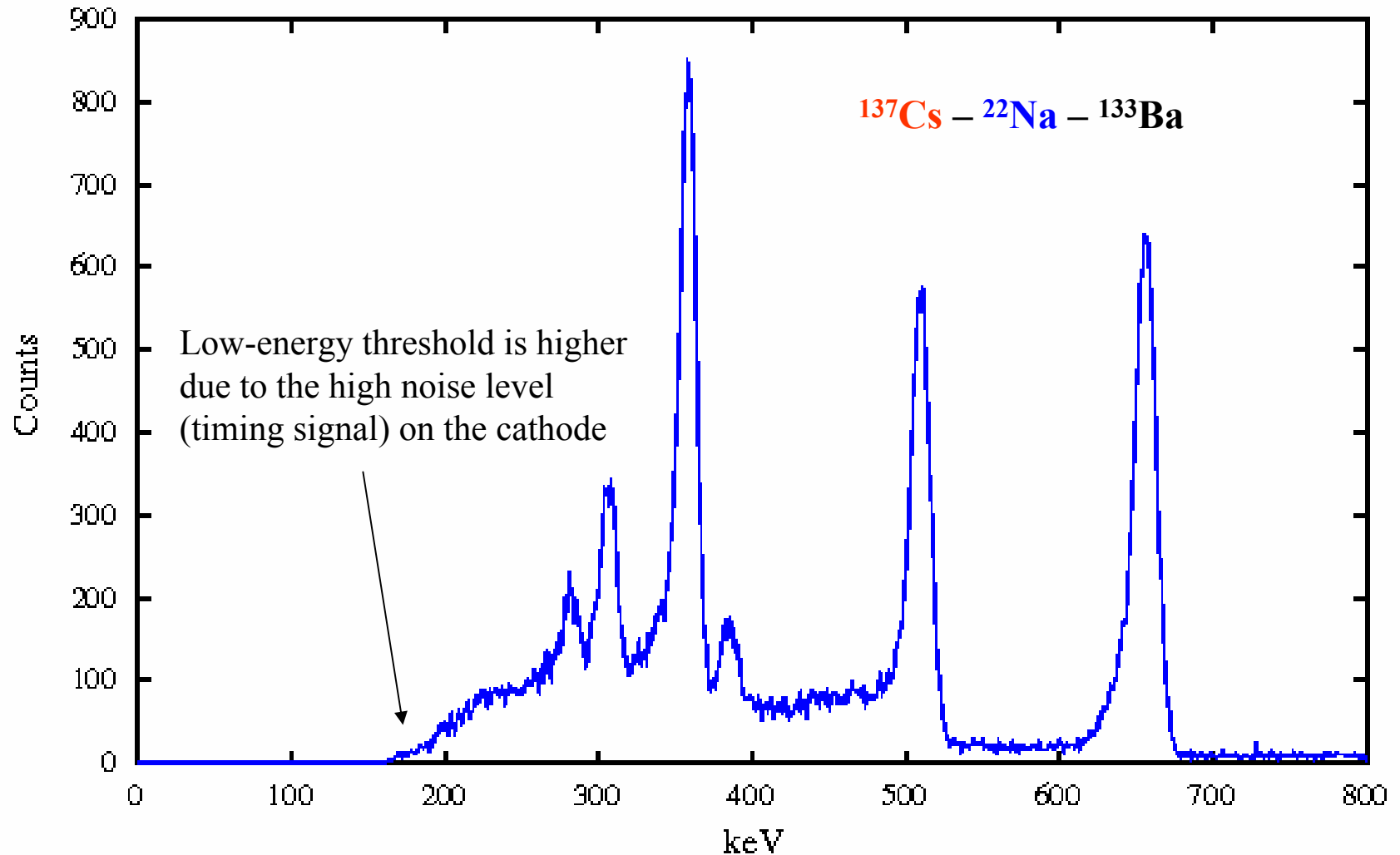
# Measurement of multiple sources (**one-pixel** events)

Detector # **2.2** (120 working pixels):  $V_C = -1400$  V;  $V_{A-G} = 90$  V; Time = 1 h

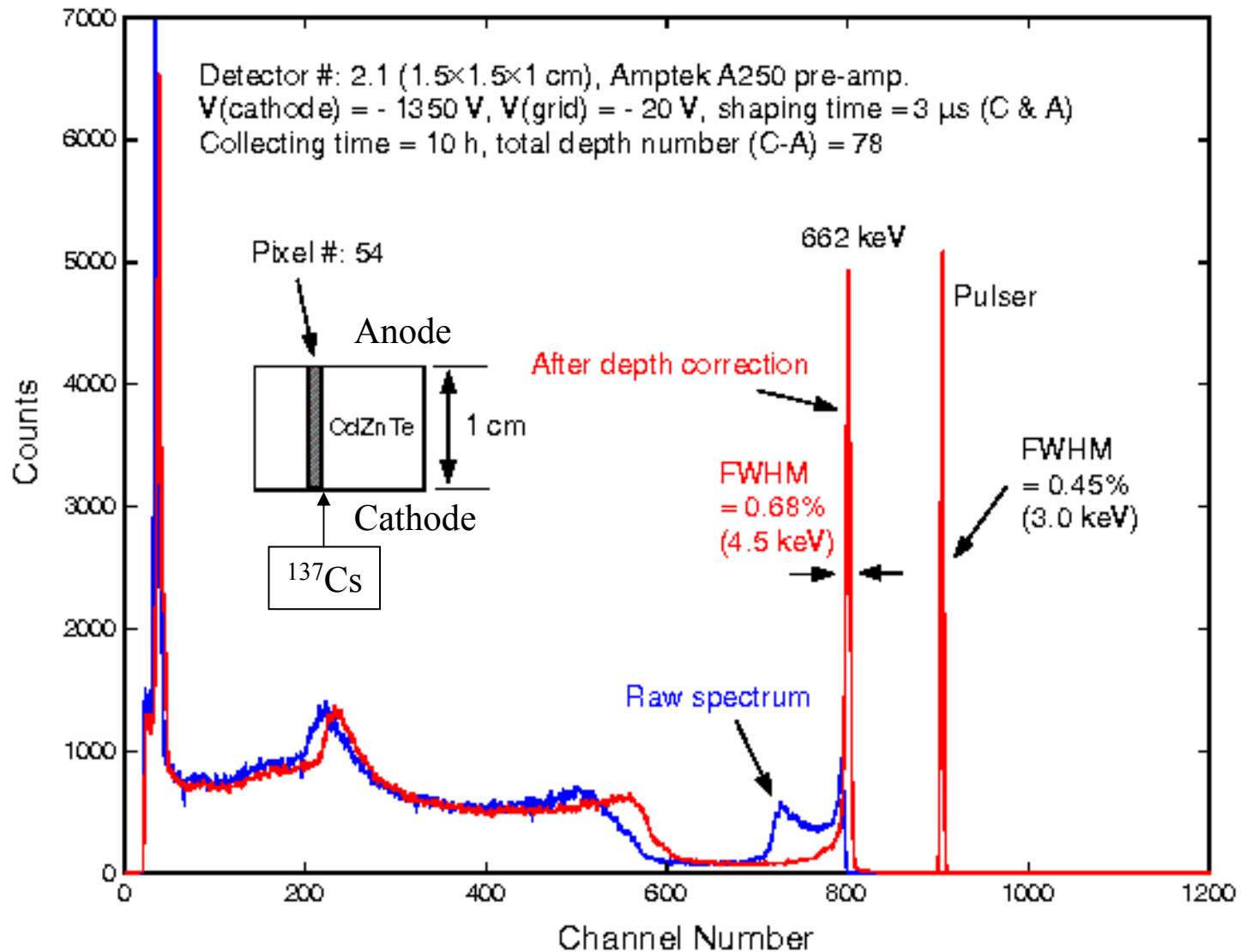


# Measurement of multiple sources (**two-pixel** events)

Detector # **2.2** (120 working pixels):  $V_C = -1400$  V;  $V_{A-G} = 90$  V; Time = 1 h



# When ASIC noise is reduced to 3 keV FWHM



# Summary on 3-D CdZnTe

- Energy resolution:
  - 1.1% FWHM at 662 keV for single-pixel events → (?)
  - 2.0% FWHM for two-pixel events → ?
- Position resolution in 3-D:
  - 1.2 mm in X-Y and ~ 0.5 mm in Z at 662 keV
- Energy depositions and 3-D positions of multiple-interactions are **fully readout using ASIC** for the **first** time.
- Current development:
  - Improvement on ASIC (Testing 3<sup>rd</sup> design iteration ASICs)
  - Larger detectors
  - Miniaturize** ASIC (for tile-able systems)
- Detector operation can be **simple** for end users



# **3-Dimensional Position-Sensitive HgI<sub>2</sub> γ-Ray Spectrometers**

Zhong He and James E. Baciaak

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and NASA STTR program

# Facts on HgI<sub>2</sub>

- Advantageous

- high Z (80-53)

- high density (6.4 g/cm<sup>3</sup>)

- (1 cm HgI<sub>2</sub> ≈ 2-3 cm of CZT, more of Ge)

- large band-gap (2.13 eV)

- (room-temperature operation)

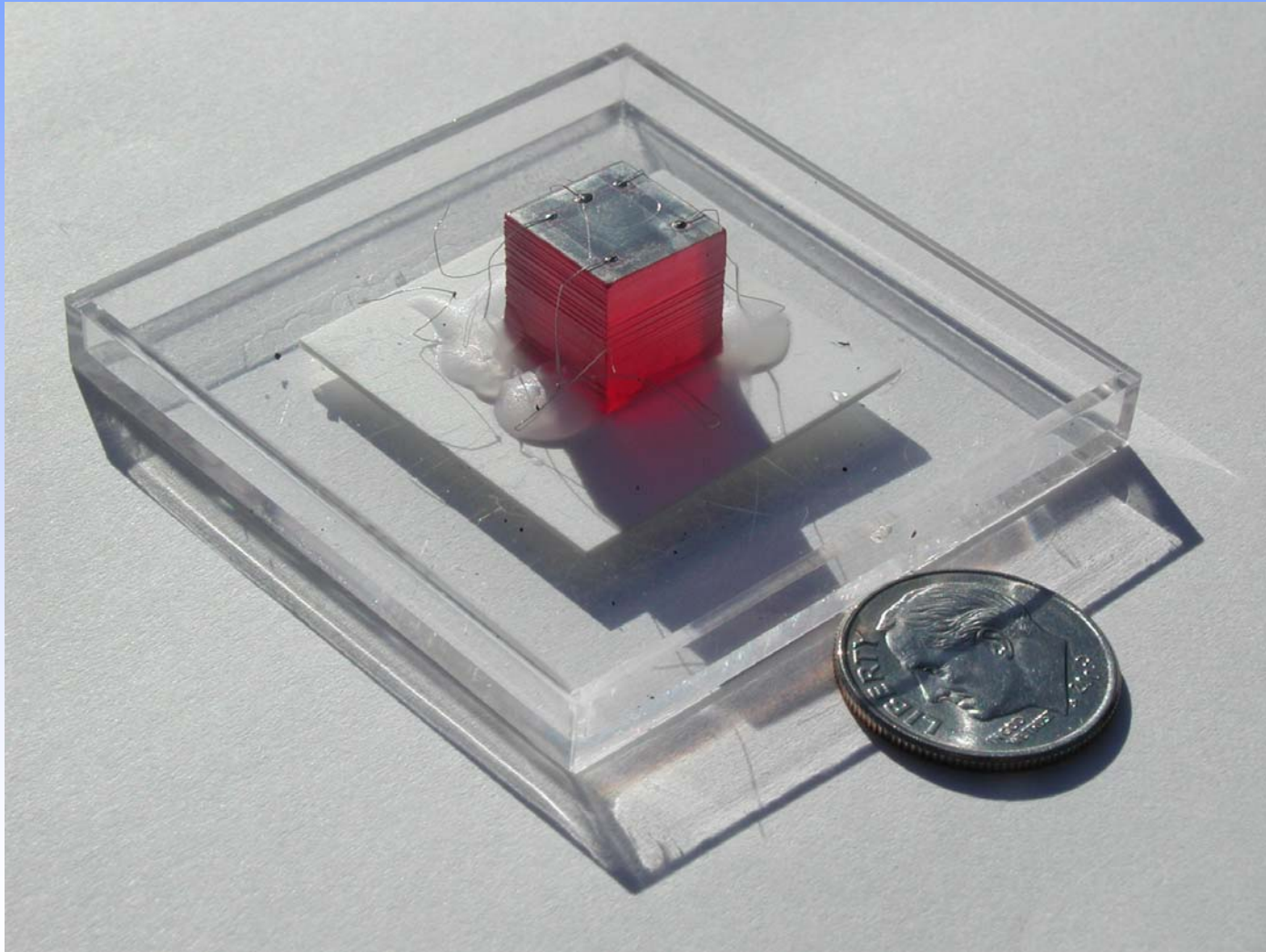
- Challenges

- very low hole mobility, severe hole trapping

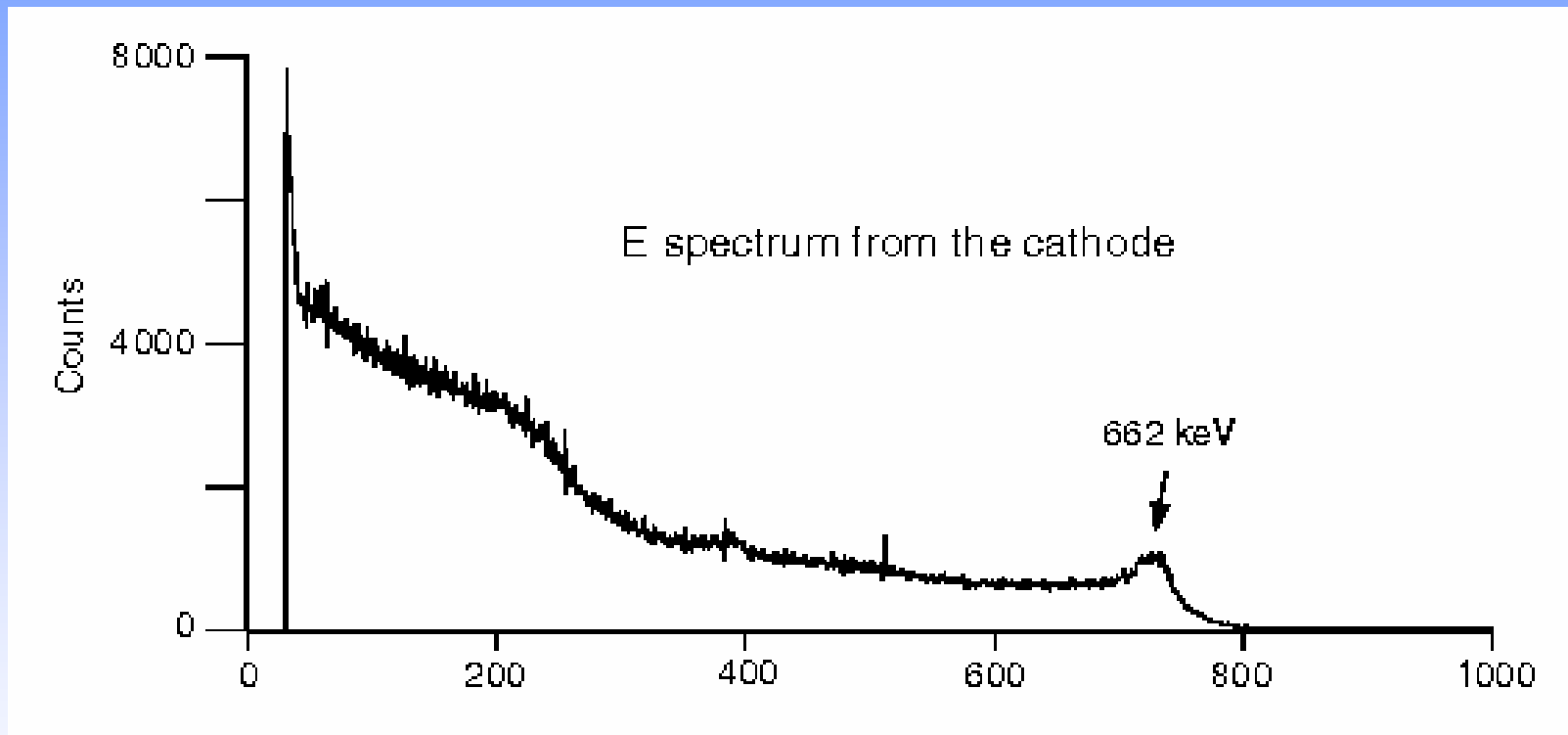
- low electron mobility

- (require higher bias ~1 kV/mm and long shaping time)

# A sample **1cm thick** HgI<sub>2</sub> Detector



If conventional readout technique is used

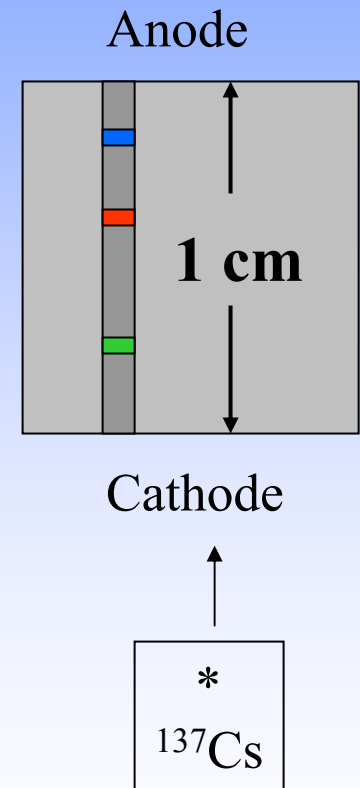
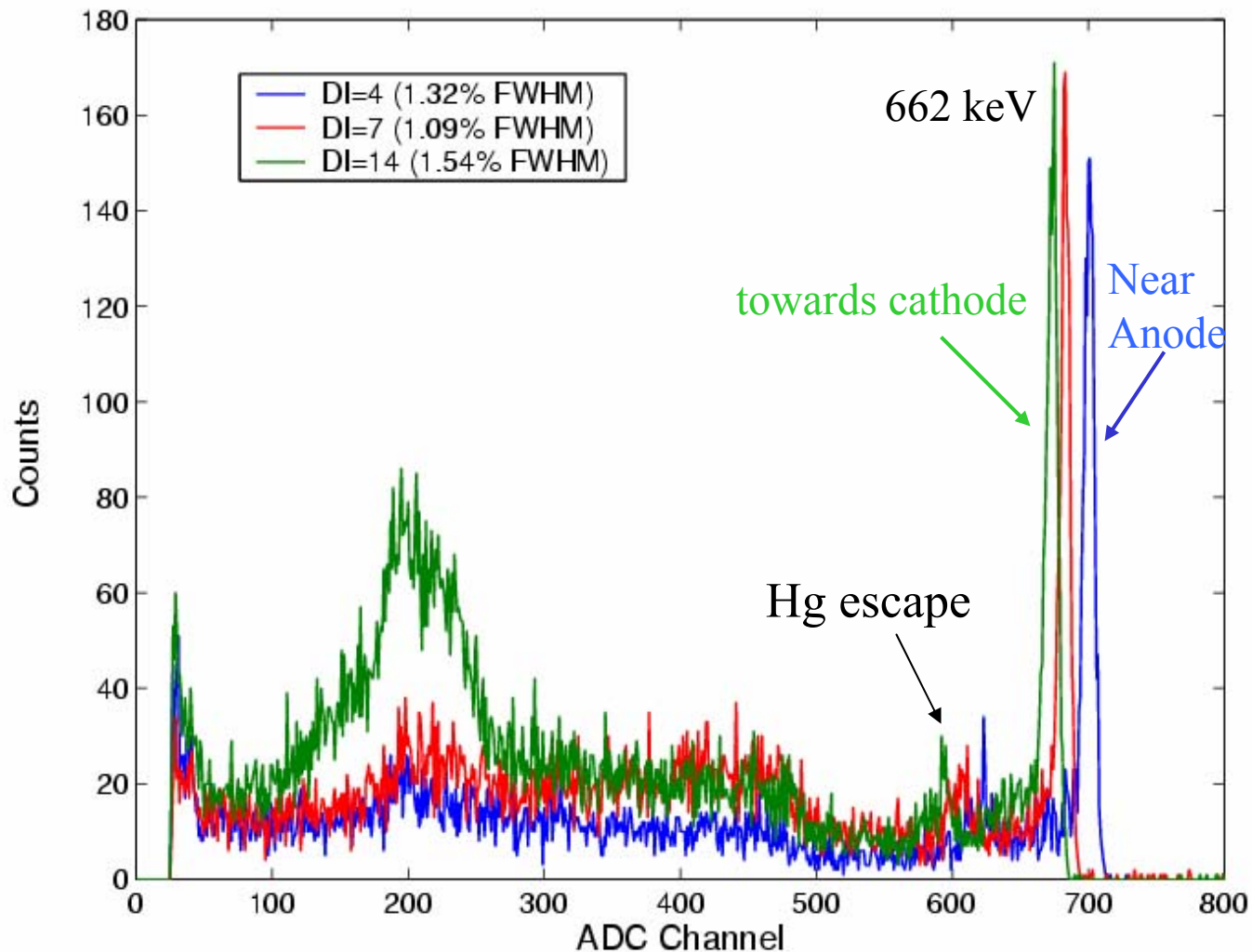


HgI<sub>2</sub> (#91321P91) = 12×12×10.05 mm

V(c) = - 2600 V;  $\tau(c)$  = 10  $\mu$ s;  $\gamma$ -rays incident from cathode

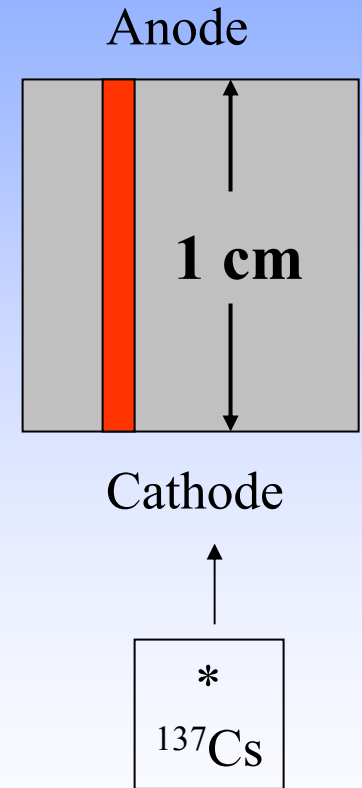
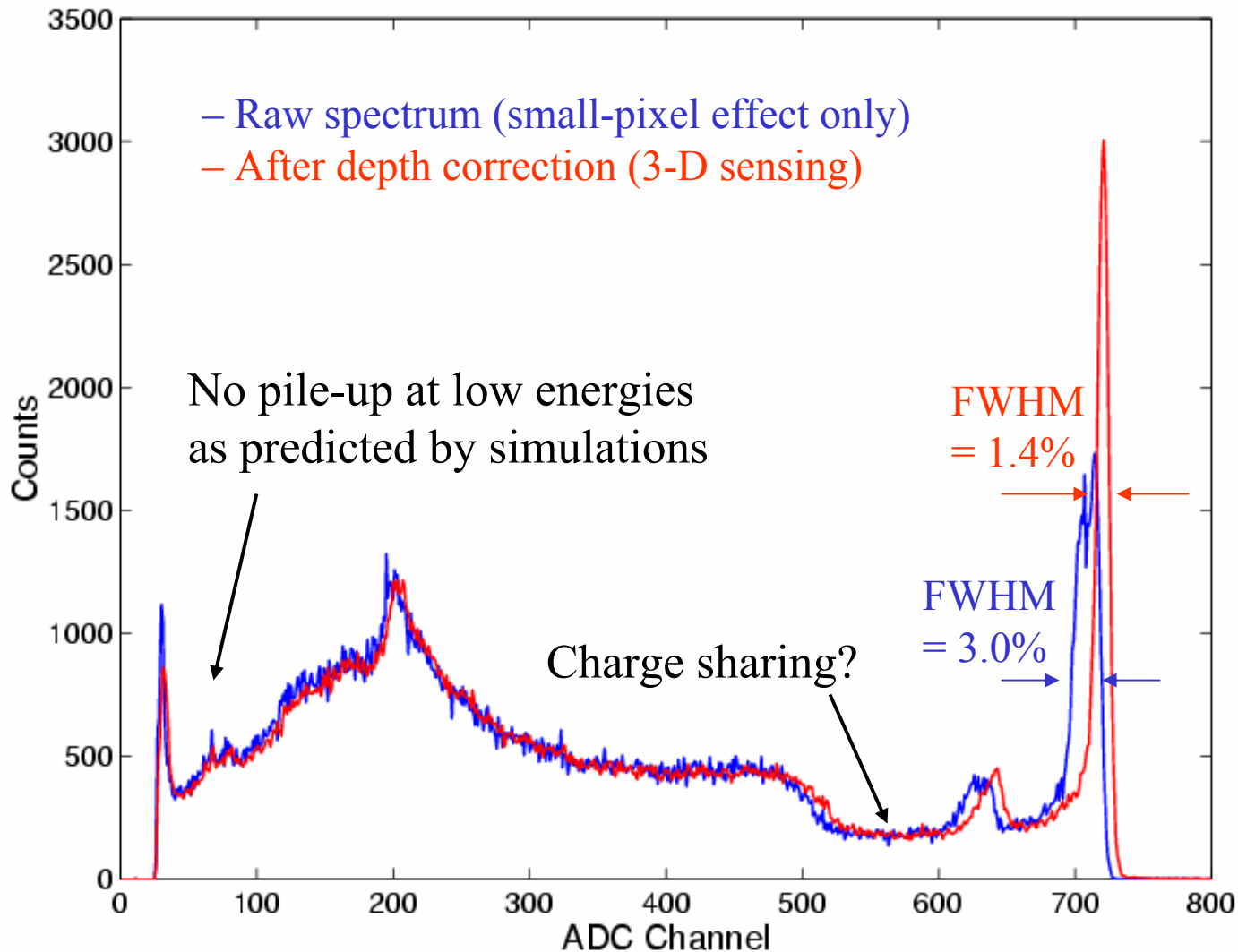
# HgI<sub>2</sub> energy spectra versus interaction depth

Detector: 93203N92; Pixel #2; V(c) = -2500 V;  $\tau(a) = 16 \mu\text{s}$ ;  $\tau(c) = 8 \mu\text{s}$



# Energy spectrum from a 1 cm thick HgI<sub>2</sub> detector

Detector: 93203N91; Pixel #2, V(c) = -2500 V;  $\tau(a) = \tau(c) = 8 \mu\text{s}$

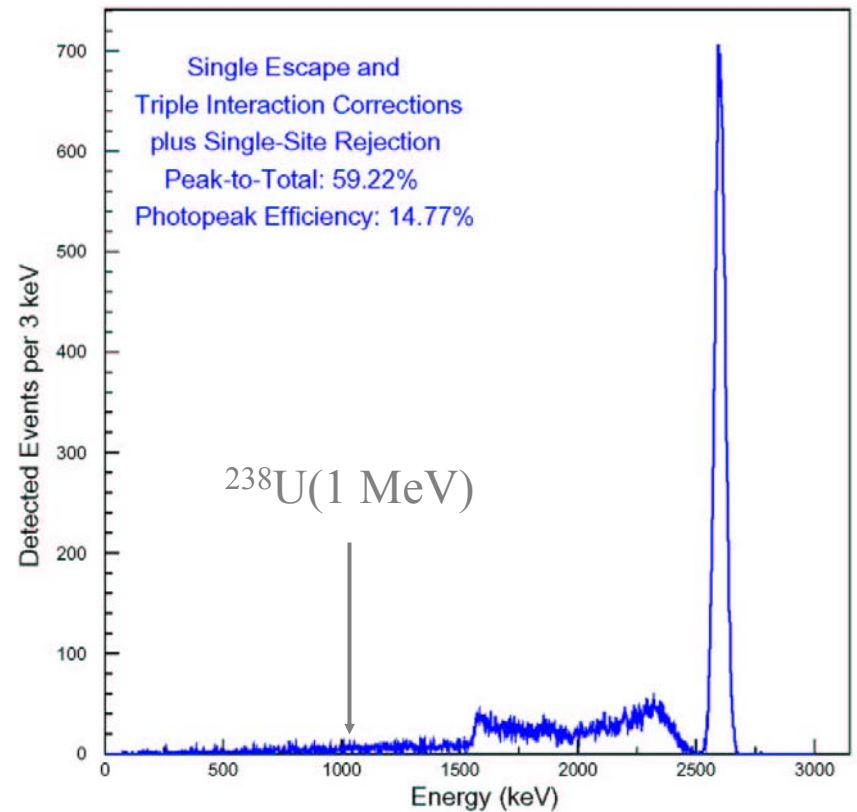
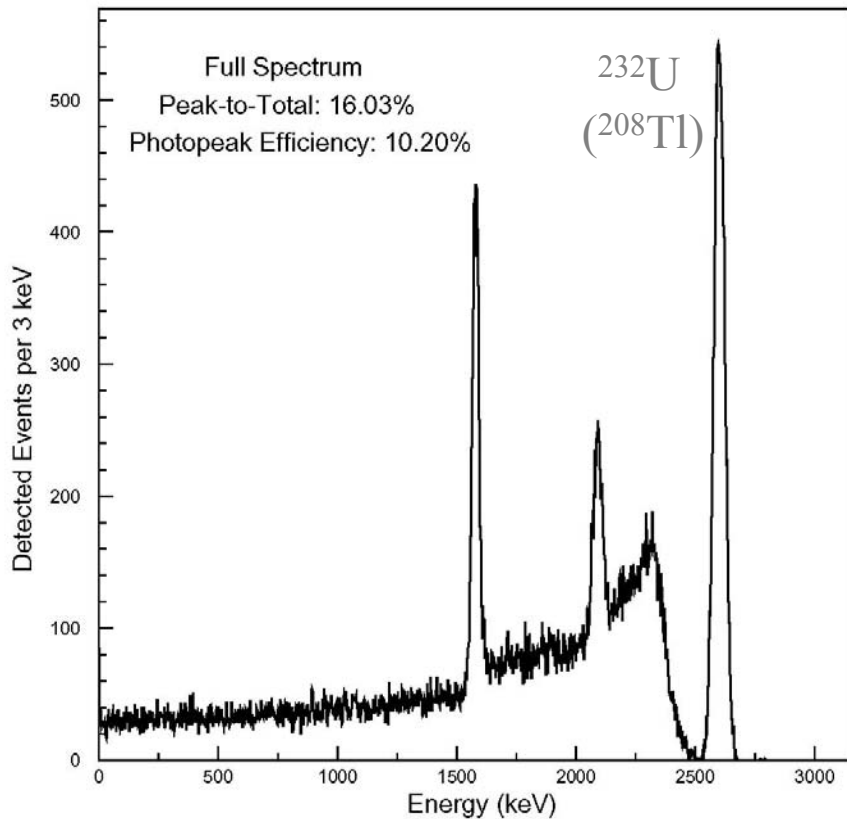


## Conclusions on HgI<sub>2</sub>

- It is possible to construct HgI<sub>2</sub> gamma-ray spectrometers at thickness  $\sim$  **1 cm** if a **3-D** position sensitive single-polarity charge sensing technique is employed, and using **low biases** (2-2.6 kV) and **moderate shaping times** (6-10  $\mu$ s).
- Energy resolutions of 1.4% - 2% FWHM at 662 keV were obtained from **6 out of 7** pixel anodes.
- There is a **potential** to achieve better resolution on **1 cm thick devices**.

# Comparison between conventional and 3-D detectors for gamma spectroscopy

Detector =  $2 \times 2 \times 4.5$  cm CdZnTe



The sensitivity can be significantly improved  
(Especially useful when the background is high)